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(71) Applicant (for all designated States except US): **LG IN-
NOTEK CO., LTD.** [KR/KR]; Seoul Square, 541, Nam-
daemunno 5-ga, Jung-gu, Seoul 100-714 (KR).

(72) Inventors; and

(75) Inventors/Applicants (for US only): **KIM, Hae Yeon**
[KR/KR]; Seoul Square, 541, Namdaemunno 5-ga, Jung-
gu, Seoul 100-714 (KR). **MOON, Sung Bae** [KR/KR];
Seoul Square, 541, Namdaemunno 5-ga, Jung-gu, Seoul
100-714 (KR). **PARK, Jae Man** [KR/KR]; Seoul Square,
541, Namdaemunno 5-ga, Jung-gu, Seoul 100-714 (KR).
PARK, Jeung Ook [KR/KR]; Seoul Square, 541, Nam-
daemunno 5-ga, Jung-gu, Seoul 100-714 (KR). **YOON,
Jong Heum** [KR/KR]; Seoul Square, 541, Namdaemunno
5-ga, Jung-gu, Seoul 100-714 (KR). **CHO, In Hee**
[KR/KR]; Seoul Square, 541, Namdaemunno 5-ga, Jung-
gu, Seoul 100-714 (KR).

(74) Agent: **SEO, Kyo Jun**; 9th Fl. Hyun Juk Bldg., 832-
41, Yeoksam-dong, Gangnam-gu, Seoul 135-080 (KR).

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BZ, CA, CH, CL, CN, CO, CR, CU, CZ, DE, DK, DM,
DO, DZ, EC, EE, EG, ES, FI, GB, GD, GE, GH, GM, GT,
HN, HR, HU, ID, IL, IN, IS, JP, KE, KG, KM, KN, KP,
KZ, LA, LC, LK, LR, LS, LT, LU, LY, MA, MD, ME,
MG, MK, MN, MW, MX, MY, MZ, NA, NG, NI, NO, NZ,
OM, PE, PG, PH, PL, PT, QA, RO, RS, RU, RW, SC, SD,
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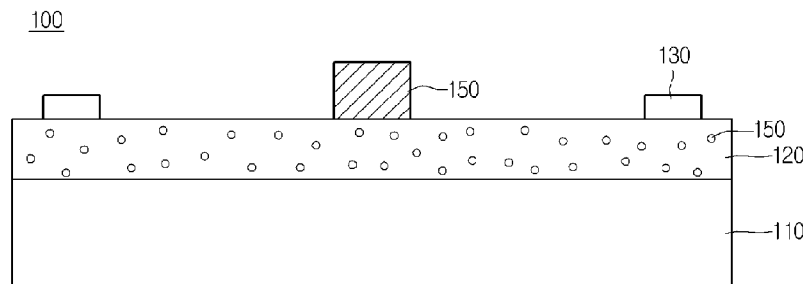
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(54) Title: EPOXY RESIN COMPOUND AND RADIANT HEAT CIRCUIT BOARD USING THE SAME



(57) Abstract: An epoxy resin compound having an epoxy resin, a curing agent, and inorganic filler as main components is provided. The epoxy resin includes an epoxy resin of Chemical Formula. Accordingly, the thermal conductivity of the epoxy resin compound can be increased because the epoxy resin has a mesogen structure that facilitates crystallizability. In addition, a high radiant heat board can be provided by using the above-mentioned epoxy resin as an insulating material for a printed circuit board.



INTERNATIONAL SEARCH REPORT

International application No.
PCT/KR2012/006919**A. CLASSIFICATION OF SUBJECT MATTER***C08G 59/20(2006.01)i, C08L 63/00(2006.01)i, C08K 3/00(2006.01)i, H05K 7/20(2006.01)i*

According to International Patent Classification (IPC) or to both national classification and IPC

B. FIELDS SEARCHED

Minimum documentation searched (classification system followed by classification symbols)

C08G 59/20; C08L 63/00; C08G 59/06; C08G 59/62; H01L 23/29; C08G 59/24

Documentation searched other than minimum documentation to the extent that such documents are included in the fields searched

Korean utility models and applications for utility models

Japanese utility models and applications for utility models

Electronic data base consulted during the international search (name of data base and, where practicable, search terms used)

eKOMPASS(KIPO internal) & Keywords: epoxy, curing, accelerator, bisphenol, filler, circuit board

C. DOCUMENTS CONSIDERED TO BE RELEVANT

Category*	Citation of document, with indication, where appropriate, of the relevant passages	Relevant to claim No.
X	JP 2007-308570 A (NIPPON KAYAKU CO. LTD.) 29 November 2007 See chemical formula 1, column [0008], [0025]-[0030]	1-16
X	JP 2008-156403 A (MATSUSHITA ELECTRIC WORKS LTD.) 10 July 2008 See chemical formula 1, column [0026], [0034], claim 1	1-16
X	KR 10-2007-0009621 A (SUMITOMO BAKELITE CO., LTD.) 18 January 2007 See chemical formula 1, claims 1-4	1-16
A	JP 08-081542 A (TOSHIBA CHEM. CORP.) 26 March 1996 See abstract	1-16

 Further documents are listed in the continuation of Box C. See patent family annex.

* Special categories of cited documents:

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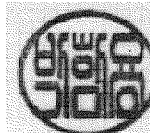
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Authorized officer

PARK, Ham Yong

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INTERNATIONAL SEARCH REPORT

Information on patent family members

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Patent document cited in search report	Publication date	Patent family member(s)	Publication date
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